

## High speed 1200 V TRENCHSTOP™ IGBT 7 Technology co-packed with full rated current, soft-commutating, ultra-fast recovery and low $Q_{rr}$ emitter controlled 7 Rapid diode

### Features

- $V_{CE} = 1200\text{ V}$
- $I_C = 75\text{ A}$
- Maximum junction temperature  $T_{vjmax} = 175^\circ\text{C}$
- Best-in-class high speed IGBT co-packed with full rated current, low  $Q_{rr}$  and soft-commutating high speed diode
- Low saturation voltage  $V_{CEsat} = 1.7\text{ V}$  at  $T_{vj} = 25^\circ\text{C}$
- Optimized for high efficiency in high speed hard switching topologies (2-L inverter, 3-L NPC T-type, ...)
- Easy paralleling capability due to positive temperature coefficient in  $V_{CEsat}$
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

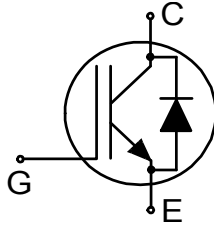
### Potential applications

- Industrial UPS
- EV-Charging
- String inverter
- Welding

### Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

### Description



| Type         | Package              | Marking |
|--------------|----------------------|---------|
| IKW75N120CH7 | PG-TO247-3-STD-NN2.5 | K75MCH7 |

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## 1 Package

**Table 1** Characteristic values

| Parameter   | Symbol        | Note or test condition                               | Values |      |      | Unit |
|---|---------------|--|--------|------|------|------|
|   |               |  | Min.   | Typ. | Max. |      |
| Internal emitter inductance measured 5 mm (0.197 in.) from case | $L_E$         |  |        | 13   |      | nH   |
| Storage temperature   | $T_{stg}$     |  | -55    |      | 150  | °C   |
| Soldering temperature   | $T_{sold}$    | wave soldering 1.6 mm (0.063 in.) from case for 10 s |        |      | 260  | °C   |
| Mounting torque   | $M$           | M3 screw, Maximum of mounting processes: 3           |        |      | 0.6  | Nm   |
| Thermal resistance, junction-ambient                            | $R_{th(j-a)}$ |  |        |      | 40   | K/W  |
| IGBT thermal resistance, junction-case                          | $R_{th(j-c)}$ |  |        | 0.21 | 0.27 | K/W  |
| Diode thermal resistance, junction-case                         | $R_{th(j-c)}$ |  |        | 0.36 | 0.47 | K/W  |

## 2 IGBT

**Table 2** Maximum rated values

| Parameter  | Symbol       | Note or test condition  | Values                 | Unit |   |
|--|--------------|---|------------------------|------|---|
| Collector-emitter voltage                              | $V_{CE}$     | $T_{vj} \geq 25 \text{ °C}$   | 1200                   | V    |   |
| DC collector current, limited by $T_{vjmax}$           | $I_C$        | limited by bondwire   | $T_c = 25 \text{ °C}$  | 92   | A |
|  |              |   | $T_c = 100 \text{ °C}$ | 81   |   |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$ | $I_{Cpulse}$ |   | 300                    | A    |   |
| Turn-off safe operating area                           |              | $V_{CC} \leq 800 \text{ V}$ , $V_{CE,peak} < 1200 \text{ V}$ , $V_{GE} = 0/15 \text{ V}$ , $R_{Goff} \geq 5.3 \text{ } \Omega$ , $T_{vj} \leq 175 \text{ °C}$ | 300                    | A    |   |
| Gate-emitter voltage                                   | $V_{GE}$     |   | $\pm 20$               | V    |   |
| Transient gate-emitter voltage                         | $V_{GE}$     | $t_p \leq 0.5 \text{ } \mu\text{s}$ , $D < 0.001$   | $\pm 25$               | V    |   |
| Power dissipation                                      | $P_{tot}$    |   | $T_c = 25 \text{ °C}$  | 549  | W |
|  |              |   | $T_c = 100 \text{ °C}$ | 275  |   |

**Table 3 Characteristic values**

| Parameter                            | Symbol       | Note or test condition   |   | Values |      |      | Unit          |
|--------------------------------------|--------------|--|---|--------|------|------|---------------|
|                                      |              |  |   | Min.   | Typ. | Max. |               |
| Collector-emitter saturation voltage | $V_{CEsat}$  | $I_C = 75\text{ A}, V_{GE} = 15\text{ V}$  | $T_{vj} = 25\text{ °C}$                     |        | 1.7  | 2.15 | V             |
|                                      |              |  | $T_{vj} = 175\text{ °C}$                    |        | 2    |      |               |
| Gate-emitter threshold voltage       | $V_{GEth}$   | $I_C = 1.2\text{ mA}, V_{CE} = V_{GE}$   |   | 4.7    | 5.5  | 6.2  | V             |
| Zero gate-voltage collector current  | $I_{CES}$    | $V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}$  | $T_{vj} = 25\text{ °C}$                     |        |      | 40   | $\mu\text{A}$ |
|                                      |              |  | $T_{vj} = 175\text{ °C}$                    |        | 4600 |      |               |
| Gate-emitter leakage current         | $I_{GES}$    | $V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}$  |   |        |      | 100  | nA            |
| Transconductance                     | $g_{fs}$     | $I_C = 75\text{ A}, V_{CE} = 20\text{ V}$  |   |        | 123  |      | S             |
| Input capacitance                    | $C_{ies}$    | $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 100\text{ kHz}$                                |   |        | 9.6  |      | nF            |
| Output capacitance                   | $C_{oes}$    | $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 100\text{ kHz}$                                |   |        | 184  |      | pF            |
| Reverse transfer capacitance         | $C_{res}$    | $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 100\text{ kHz}$                                |   |        | 54   |      | pF            |
| Gate charge                          | $Q_G$        | $V_{CC} = 960\text{ V}, I_C = 75\text{ A}, V_{GE} = 15\text{ V}$                               |   |        | 535  |      | nC            |
| Turn-on delay time                   | $t_{d(on)}$  | $V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 8\ \Omega, R_{G(off)} = 8\ \Omega$ | $T_{vj} = 25\text{ °C}, I_C = 75\text{ A}$  |        | 55   |      | ns            |
|                                      |              |  | $T_{vj} = 175\text{ °C}, I_C = 75\text{ A}$ |        | 52   |      |               |
| Rise time (inductive load)           | $t_r$        | $V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 8\ \Omega, R_{G(off)} = 8\ \Omega$ | $T_{vj} = 25\text{ °C}, I_C = 75\text{ A}$  |        | 41   |      | ns            |
|                                      |              |  | $T_{vj} = 175\text{ °C}, I_C = 75\text{ A}$ |        | 36   |      |               |
| Turn-off delay time                  | $t_{d(off)}$ | $V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 8\ \Omega, R_{G(off)} = 8\ \Omega$ | $T_{vj} = 25\text{ °C}, I_C = 75\text{ A}$  |        | 461  |      | ns            |
|                                      |              |  | $T_{vj} = 175\text{ °C}, I_C = 75\text{ A}$ |        | 527  |      |               |
| Fall time (inductive load)           | $t_f$        | $V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 8\ \Omega, R_{G(off)} = 8\ \Omega$ | $T_{vj} = 25\text{ °C}, I_C = 75\text{ A}$  |        | 32   |      | ns            |
|                                      |              |  | $T_{vj} = 175\text{ °C}, I_C = 75\text{ A}$ |        | 97   |      |               |
| Turn-on energy                       | $E_{on}$     | $V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 8\ \Omega, R_{G(off)} = 8\ \Omega$ | $T_{vj} = 25\text{ °C}, I_C = 75\text{ A}$  |        | 4.22 |      | mJ            |
|                                      |              |  | $T_{vj} = 175\text{ °C}, I_C = 75\text{ A}$ |        | 5.86 |      |               |

**(table continues...)**

**Table 3 (continued) Characteristic values**

| Parameter                      | Symbol    | Note or test condition   | Values  |      |      | Unit             |    |
|--------------------------------|-----------|--|---|------|------|------------------|----|
|                                |           |  | Min.  | Typ. | Max. |                  |    |
| Turn-off energy                | $E_{off}$ | $V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 8\ \Omega, R_{G(off)} = 8\ \Omega$ | $T_{vj} = 25\text{ }^\circ\text{C}, I_C = 75\text{ A}$  |      | 1.66 |                  | mJ |
|                                |           |  | $T_{vj} = 175\text{ }^\circ\text{C}, I_C = 75\text{ A}$ |      | 3.37 |                  |    |
| Total switching energy         | $E_{ts}$  | $V_{CC} = 600\text{ V}, V_{GE} = 0/15\text{ V}, R_{G(on)} = 8\ \Omega, R_{G(off)} = 8\ \Omega$ | $T_{vj} = 25\text{ }^\circ\text{C}, I_C = 75\text{ A}$  |      | 5.88 |                  | mJ |
|                                |           |  | $T_{vj} = 175\text{ }^\circ\text{C}, I_C = 75\text{ A}$ |      | 9.23 |                  |    |
| Operating junction temperature | $T_{vj}$  |  | -40   |      | 175  | $^\circ\text{C}$ |    |

Note: Electrical Characteristic, at  $T_{vj} = 25^\circ\text{C}$ , unless otherwise specified.

### 3 Diode

**Table 4 Maximum rated values**

| Parameter  | Symbol       | Note or test condition | Values                            | Unit |   |
|--|--------------|------------------------|-----------------------------------|------|---|
| Diode forward current, limited by $T_{vjmax}$      | $I_F$        | limited by bondwire    | $T_c = 25\text{ }^\circ\text{C}$  | 89   | A |
|  |              |                        | $T_c = 97\text{ }^\circ\text{C}$  | 75   |   |
| Diode pulsed current, $t_p$ limited by $T_{vjmax}$ | $I_{Fpulse}$ |                        | 300                               | A    |   |
| Power dissipation                                  | $P_{tot}$    |                        | $T_c = 25\text{ }^\circ\text{C}$  | 321  | W |
|  |              |                        | $T_c = 100\text{ }^\circ\text{C}$ | 160  |   |

**Table 5 Characteristic values**

| Parameter                     | Symbol   | Note or test condition                      | Values  |      |      | Unit |               |
|-------------------------------|----------|---|---|------|------|------|---------------|
|                               |          |   | Min.  | Typ. | Max. |      |               |
| Diode forward voltage         | $V_F$    | $I_F = 75\text{ A}$                         | $T_{vj} = 25\text{ }^\circ\text{C}$                     |      | 2.5  | 3    | V             |
|                               |          |   | $T_{vj} = 175\text{ }^\circ\text{C}$                    |      | 2.3  |      |               |
| Diode reverse recovery time   | $t_{rr}$ | $V_R = 600\text{ V}, R_{G(on)} = 8\ \Omega$ | $T_{vj} = 25\text{ }^\circ\text{C}, I_F = 75\text{ A}$  |      | 145  |      | ns            |
|                               |          |   | $T_{vj} = 175\text{ }^\circ\text{C}, I_F = 75\text{ A}$ |      | 218  |      |               |
| Diode reverse recovery charge | $Q_{rr}$ | $V_R = 600\text{ V}, R_{G(on)} = 8\ \Omega$ | $T_{vj} = 25\text{ }^\circ\text{C}, I_F = 75\text{ A}$  |      | 2.32 |      | $\mu\text{C}$ |
|                               |          |   | $T_{vj} = 175\text{ }^\circ\text{C}, I_F = 75\text{ A}$ |      | 6.41 |      |               |

(table continues...)

**Table 5 (continued) Characteristic values**

| Parameter   | Symbol       | Note or test condition                        | Values   |      |       | Unit |                  |
|---|--------------|---|--|------|-------|------|------------------|
|   |              |   | Min.   | Typ. | Max.  |      |                  |
| Diode peak reverse recovery current                 | $I_{rrm}$    | $V_R = 600 \text{ V}, R_{G(on)} = 8 \ \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C},$<br>$I_F = 75 \text{ A}$  |      | 35    |      | A                |
|   |              |   | $T_{vj} = 175 \text{ }^\circ\text{C},$<br>$I_F = 75 \text{ A}$ |      | 62    |      |                  |
| Diode peak rate of fall of reverse recovery current | $di_{rr}/dt$ | $V_R = 600 \text{ V}, R_{G(on)} = 8 \ \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C},$<br>$I_F = 75 \text{ A}$  |      | -333  |      | A/ $\mu\text{s}$ |
|   |              |   | $T_{vj} = 150 \text{ }^\circ\text{C},$<br>$I_F = 75 \text{ A}$ |      | -394  |      |                  |
| Reverse recovery energy                             | $E_{rec}$    | $V_R = 600 \text{ V}, R_{G(on)} = 8 \ \Omega$ | $T_{vj} = 25 \text{ }^\circ\text{C},$<br>$I_F = 75 \text{ A}$  |      | 0.701 |      | mJ               |
|   |              |   | $T_{vj} = 175 \text{ }^\circ\text{C},$<br>$I_F = 75 \text{ A}$ |      | 2.16  |      |                  |
| Operating junction temperature                      | $T_{vj}$     |   |  | -40  |       | 175  | $^\circ\text{C}$ |

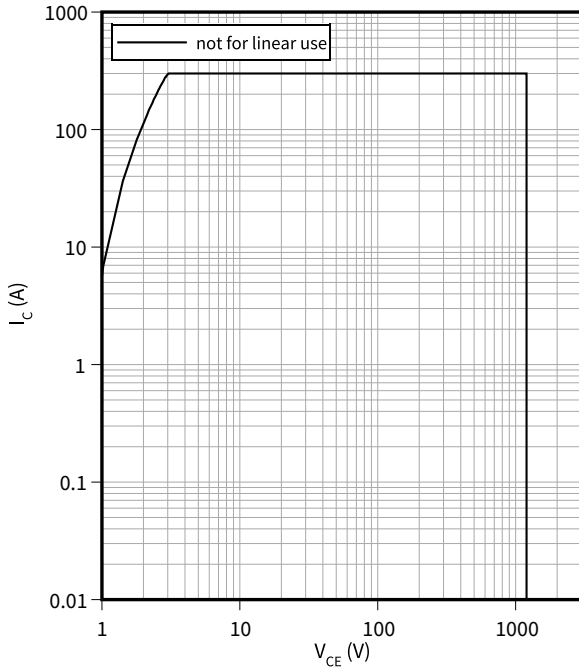
**Note:** For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Dynamic test circuit, parasitic inductance  $L_\sigma = 30 \text{ nH}$ ,  $C_\sigma = 18 \text{ pF}$

## 4 Characteristics diagrams

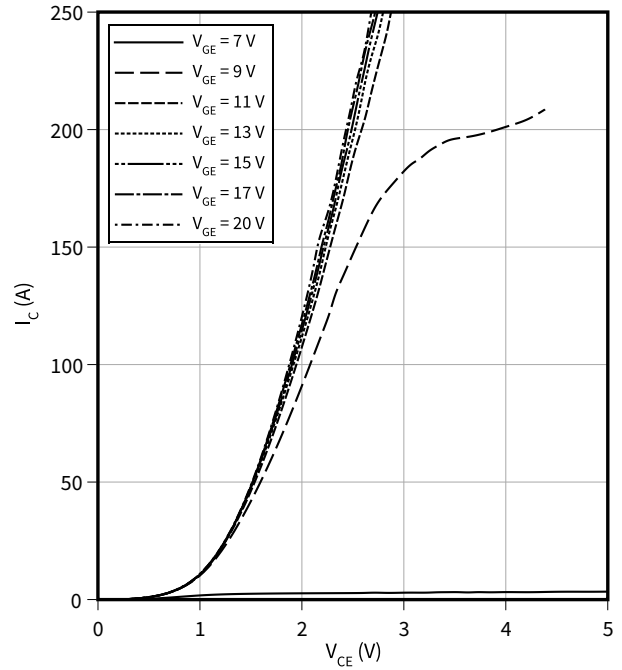
### Reverse bias safe operating area

$I_C = f(V_{CE})$   
 $T_{vj} \leq 175\text{ °C}, V_{GE} = 0/15\text{ V}$



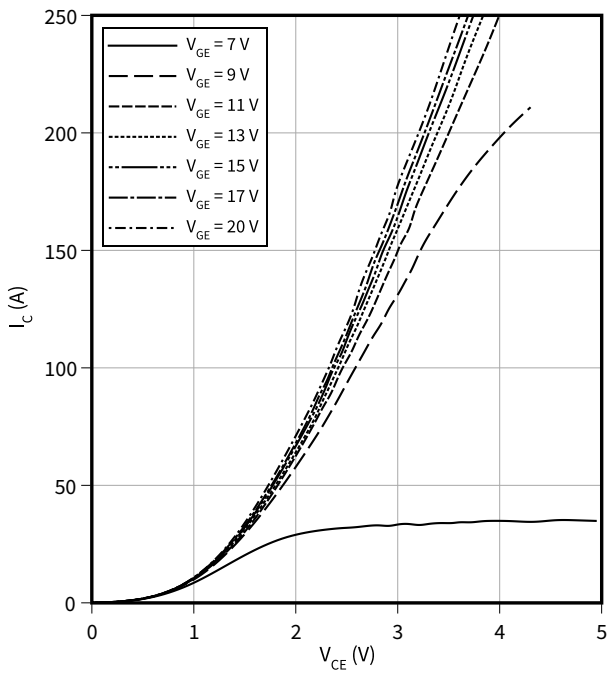
### Typical output characteristic

$I_C = f(V_{CE})$   
 $T_{vj} = 25\text{ °C}$



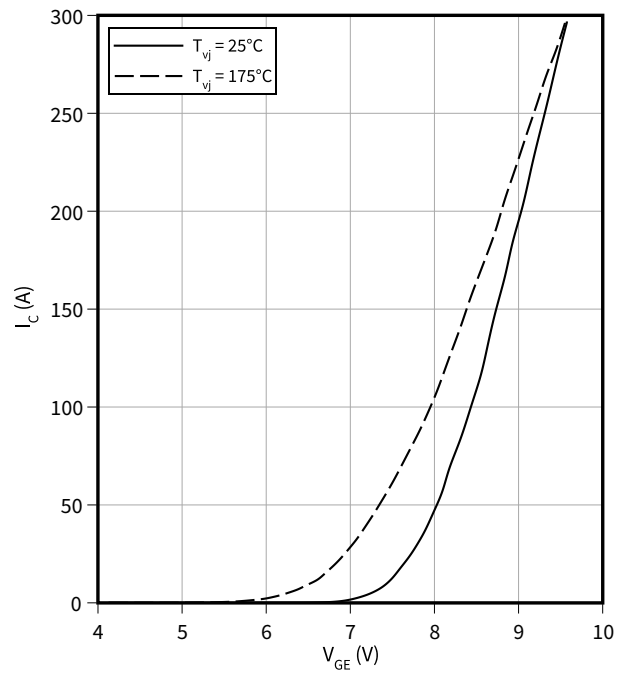
### Typical output characteristic

$I_C = f(V_{CE})$   
 $T_{vj} = 175\text{ °C}$



### Typical transfer characteristic

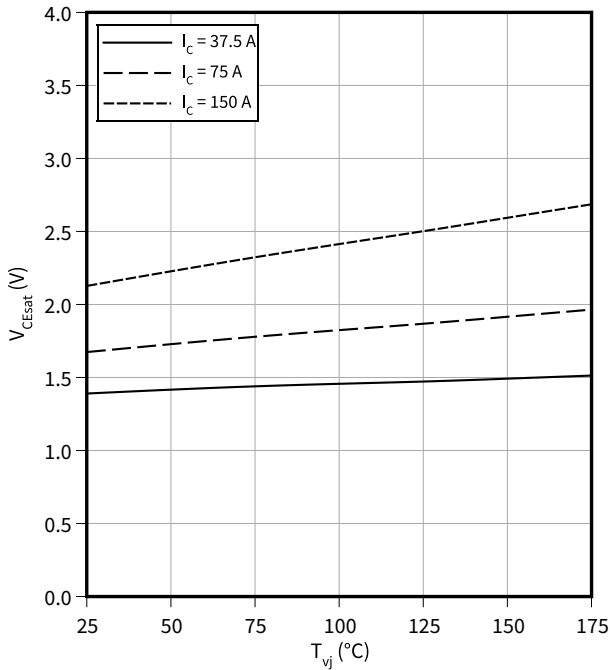
$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



4 Characteristics diagrams

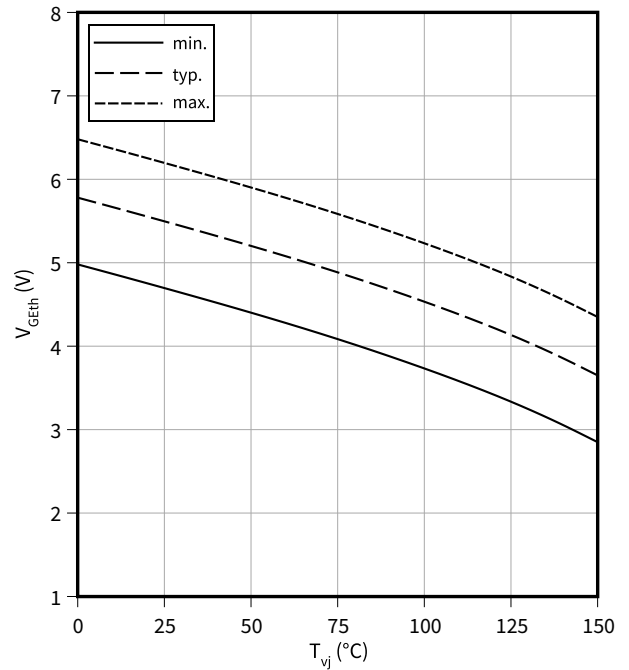
**Typical collector-emitter saturation voltage as a function of junction temperature**

$V_{CEsat} = f(T_{vj})$   
 $V_{GE} = 15 \text{ V}$



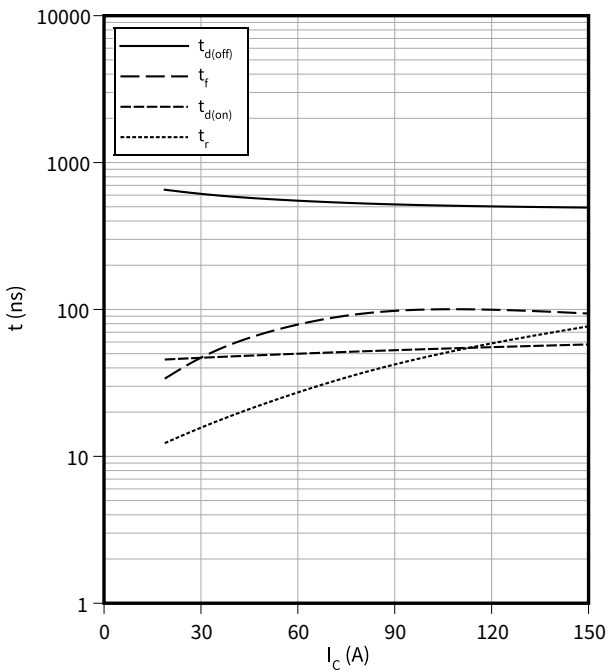
**Gate-emitter threshold voltage as a function of junction temperature**

$V_{GEth} = f(T_{vj})$   
 $I_C = 1.2 \text{ mA}$



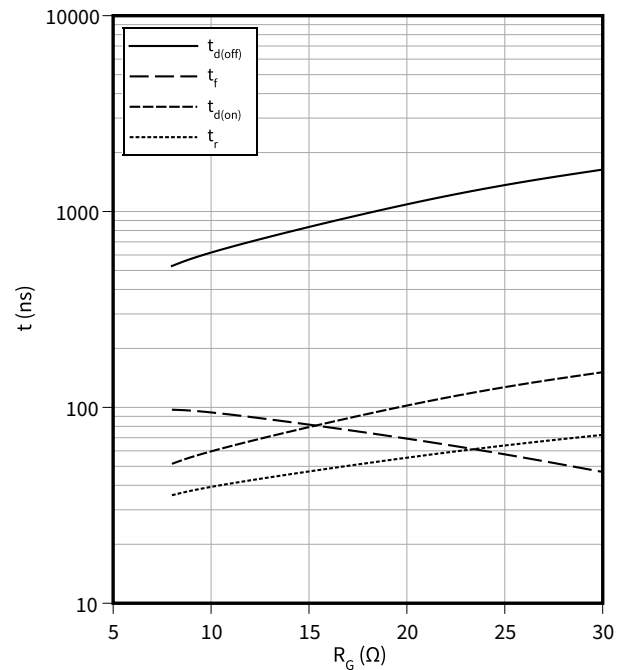
**Typical switching times as a function of collector current**

$t = f(I_C)$   
 $V_{CC} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 8 \text{ } \Omega$



**Typical switching times as a function of gate resistor**

$t = f(R_G)$   
 $I_C = 75 \text{ A}, V_{CC} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}$



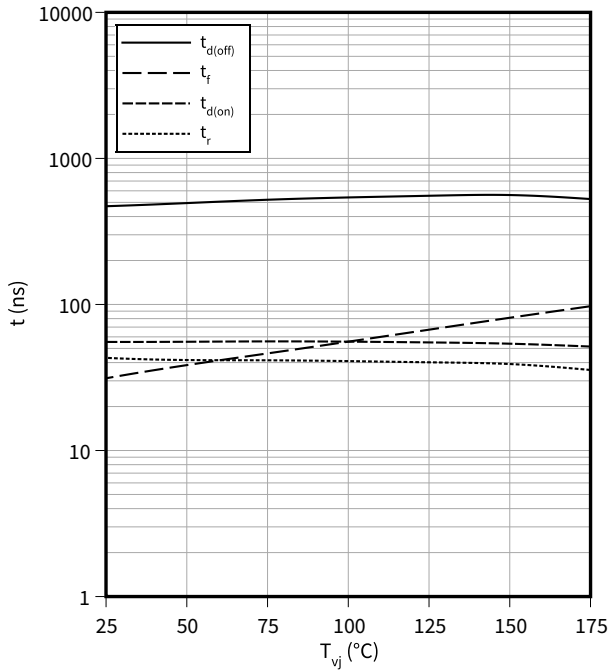


4 Characteristics diagrams

**Typical switching times as a function of junction temperature**

$t = f(T_{vj})$

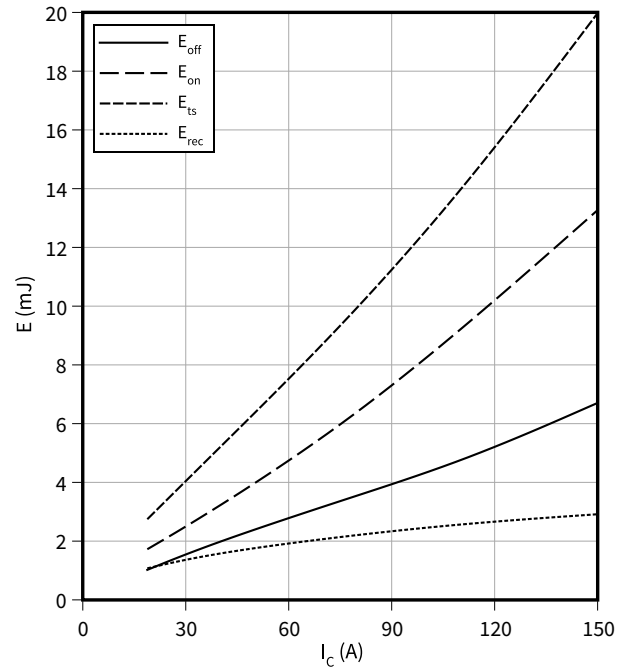
$I_C = 75 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 8 \Omega$



**Typical switching energy losses as a function of collector current**

$E = f(I_C)$

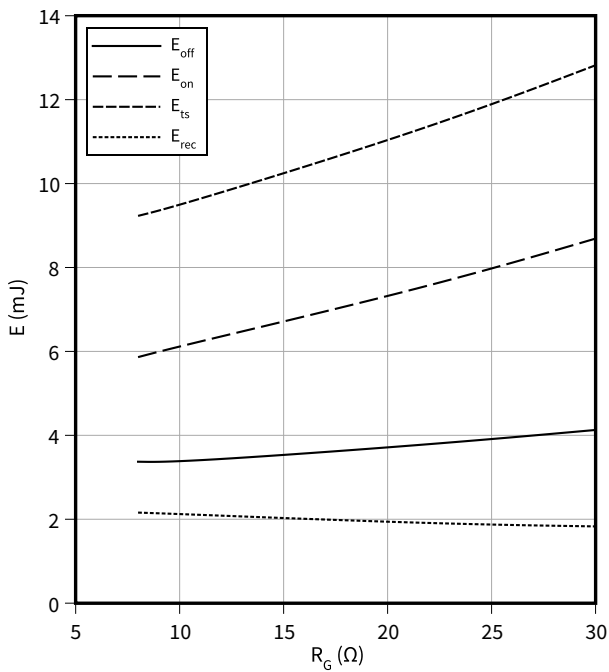
$V_{CC} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 8 \Omega$



**Typical switching energy losses as a function of gate resistor**

$E = f(R_G)$

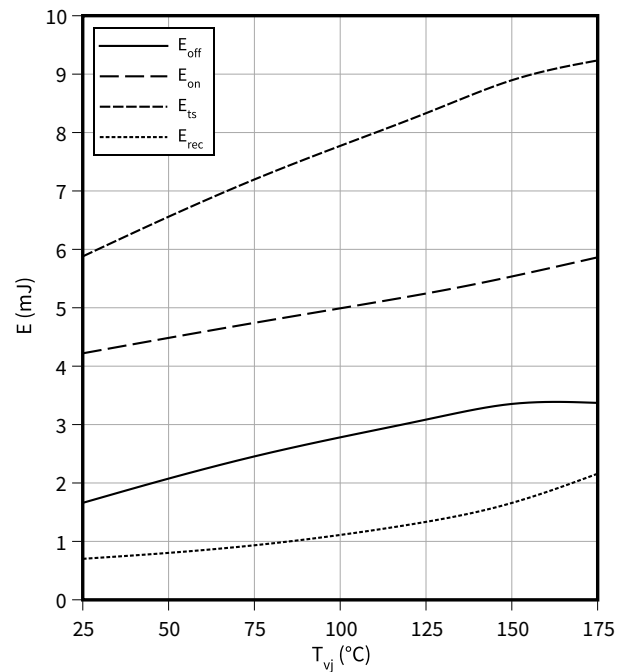
$I_C = 75 \text{ A}, V_{CC} = 600 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}$



**Typical switching energy losses as a function of junction temperature**

$E = f(T_{vj})$

$I_C = 75 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 8 \Omega$

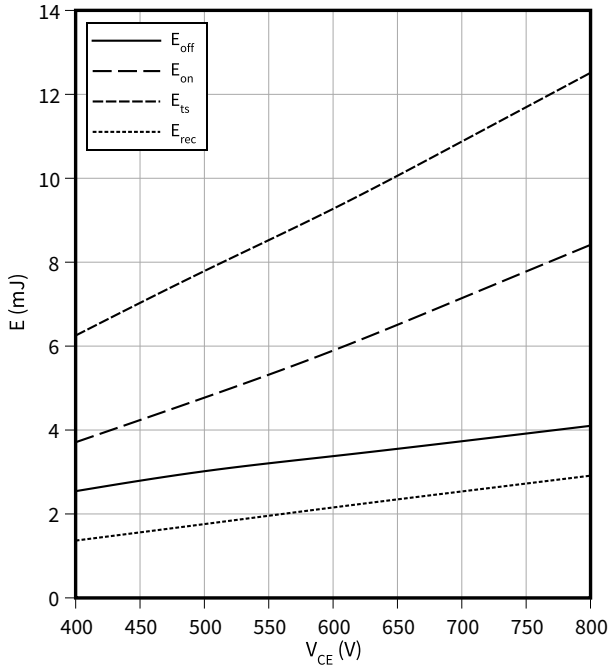


4 Characteristics diagrams

**Typical switching energy losses as a function of collector emitter voltage**

$E = f(V_{CE})$

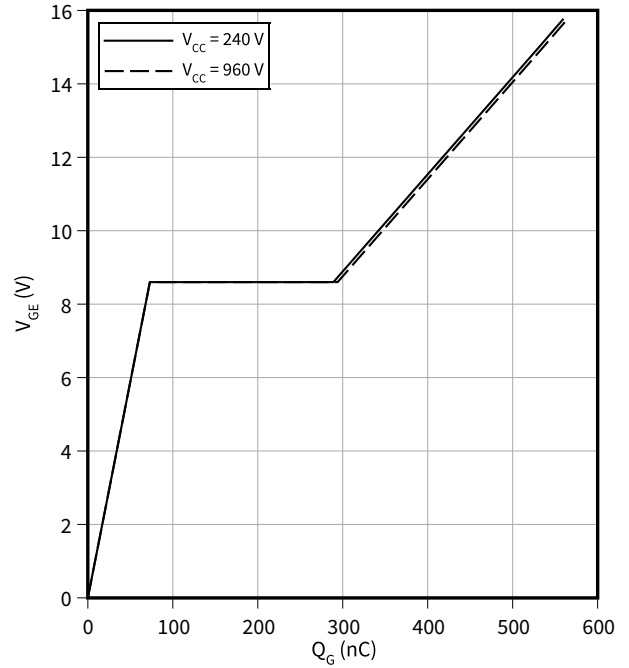
$I_C = 75 \text{ A}$ ,  $T_{vj} \geq 25 \text{ }^\circ\text{C}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 8 \text{ } \Omega$



**Typical gate charge**

$V_{GE} = f(Q_G)$

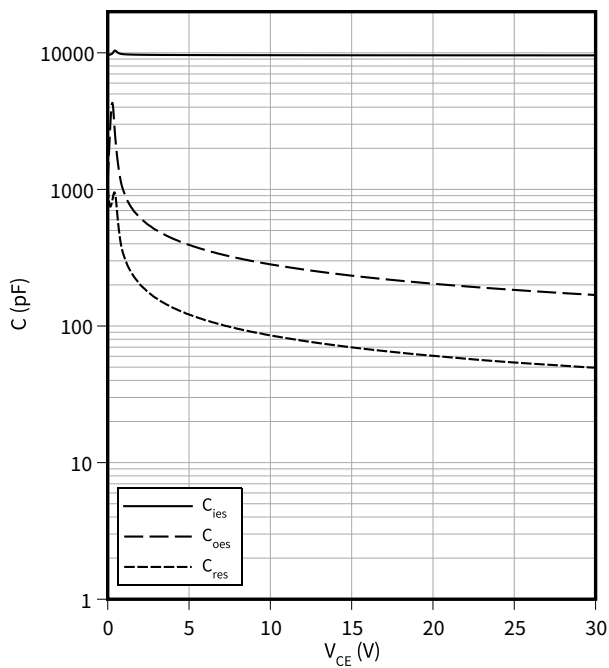
$I_C = 75 \text{ A}$



**Typical capacitance as a function of collector-emitter voltage**

$C = f(V_{CE})$

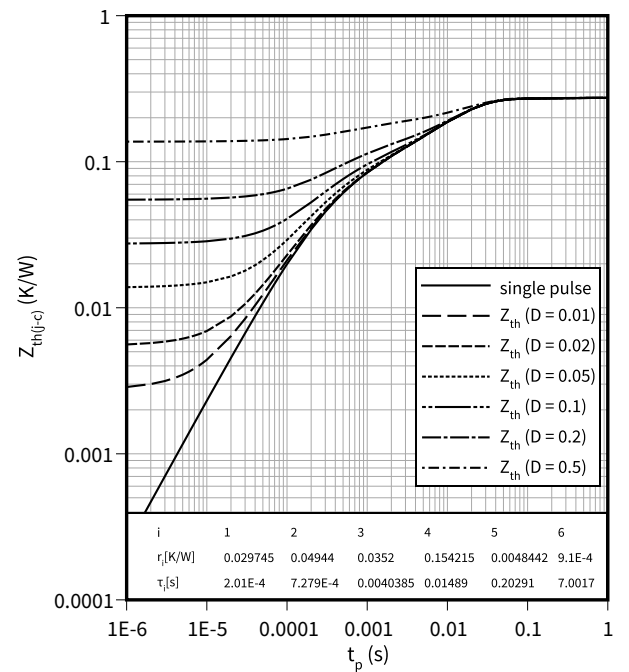
$f = 100 \text{ kHz}$ ,  $V_{GE} = 0 \text{ V}$



**IGBT transient thermal impedance as a function of pulse width**

$Z_{th(j-c)} = f(t_p)$

$D = t_p/T$

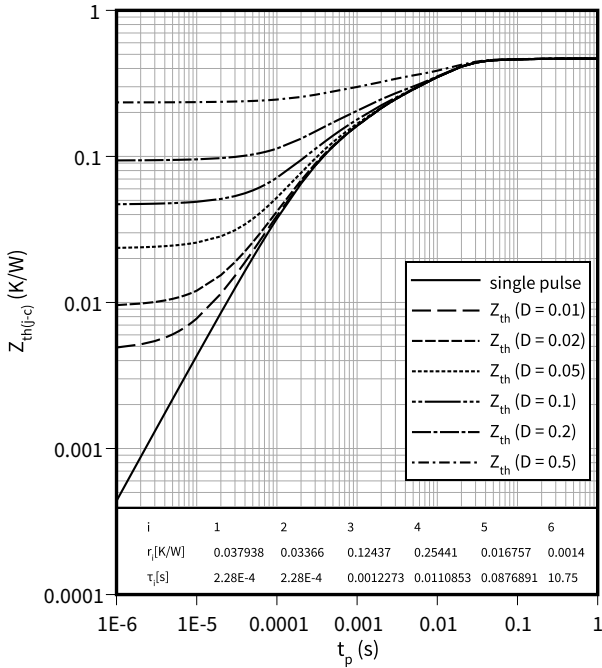


4 Characteristics diagrams

**Diode transient thermal impedance as a function of pulse width**

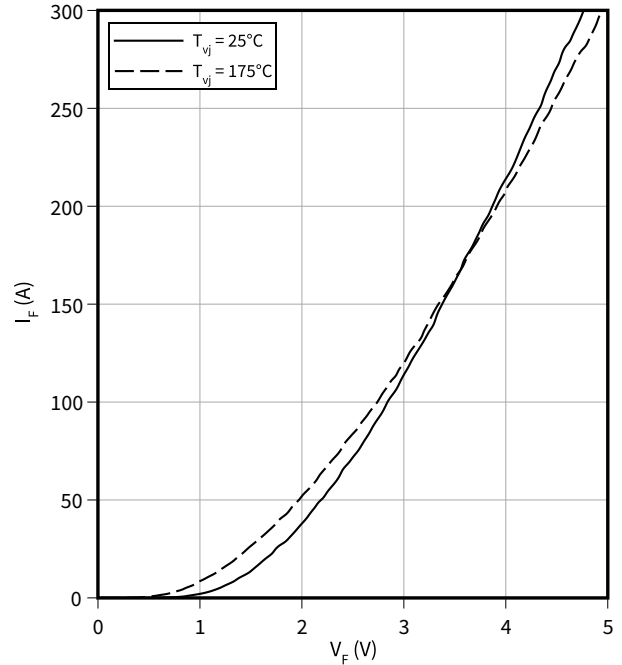
$$Z_{th(j-c)} = f(t_p)$$

$$D = t_p/T$$



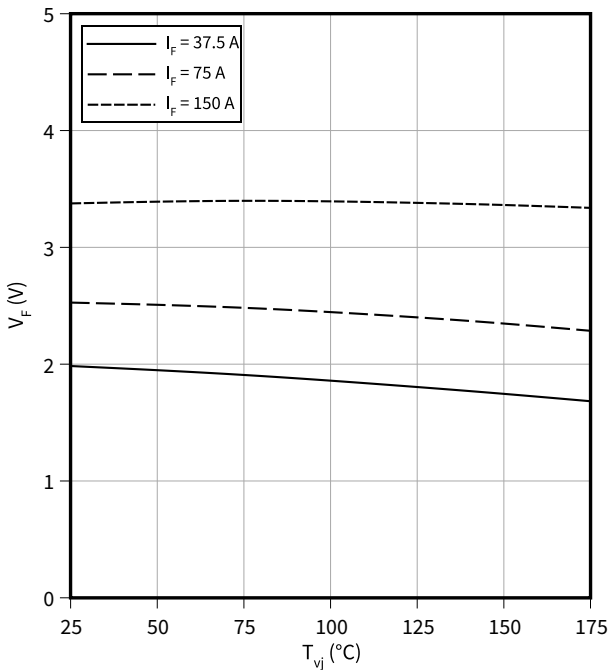
**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$



**Typical diode forward voltage as a function of junction temperature**

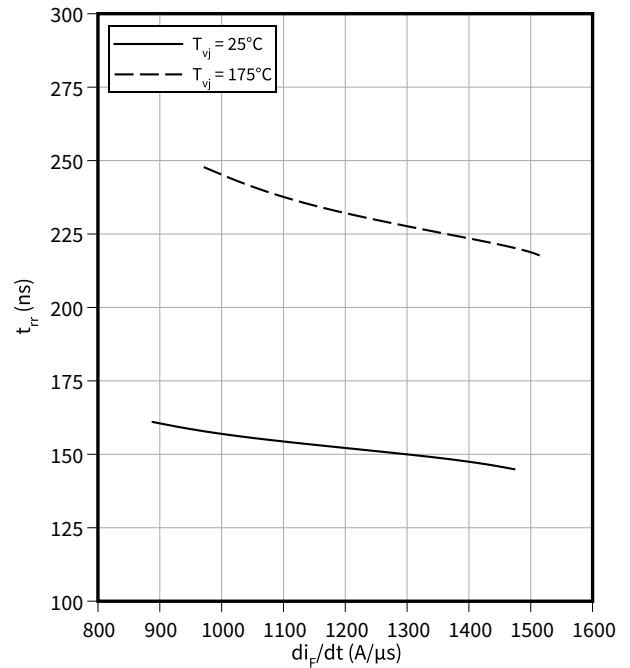
$$V_F = f(T_{vj})$$



**Typical reverse recovery time as a function of diode current slope**

$$t_{rr} = f(di_F/dt)$$

$$V_R = 600 \text{ V}, I_F = 75 \text{ A}$$

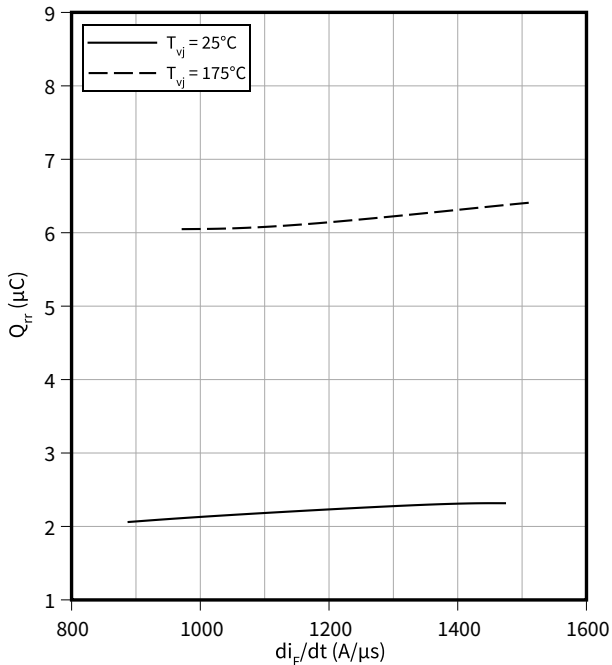


4 Characteristics diagrams

**Typical reverse recovery charge as a function of diode current slope**

$Q_{rr} = f(di_F/dt)$

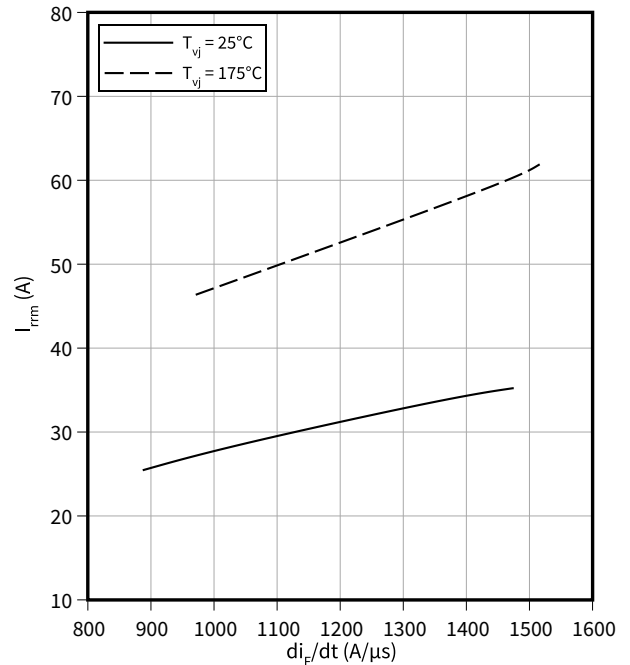
$V_R = 600\text{ V}, I_F = 75\text{ A}$



**Typical reverse recovery current as a function of diode current slope**

$I_{rrm} = f(di_F/dt)$

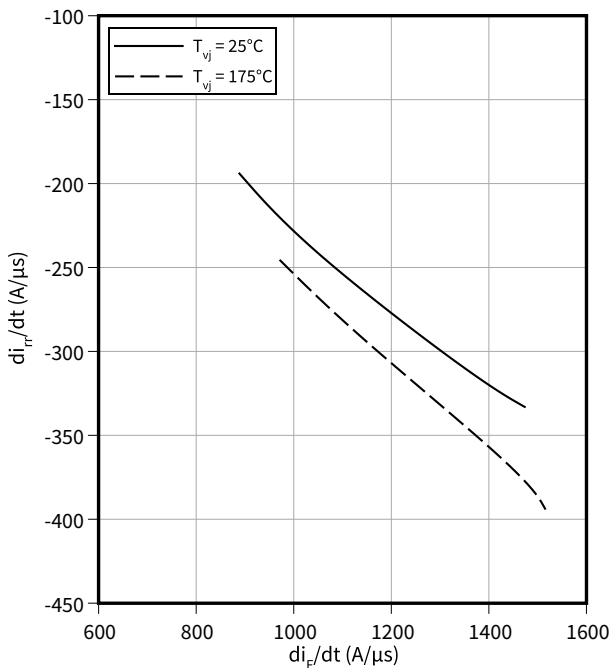
$V_R = 600\text{ V}, I_F = 75\text{ A}$



**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

$di_{rr}/dt = f(di_F/dt)$

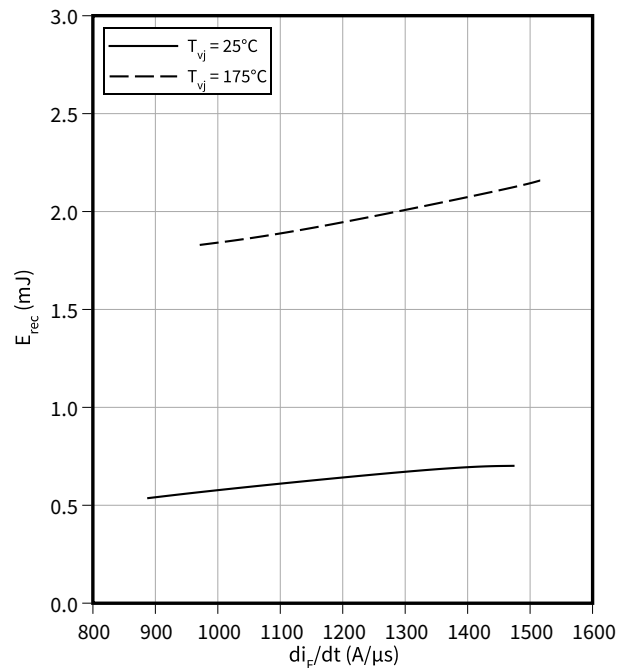
$V_R = 600\text{ V}, I_F = 75\text{ A}$



**Typical reverse energy losses as a function of diode current slope**

$E_{rec} = f(di_F/dt)$

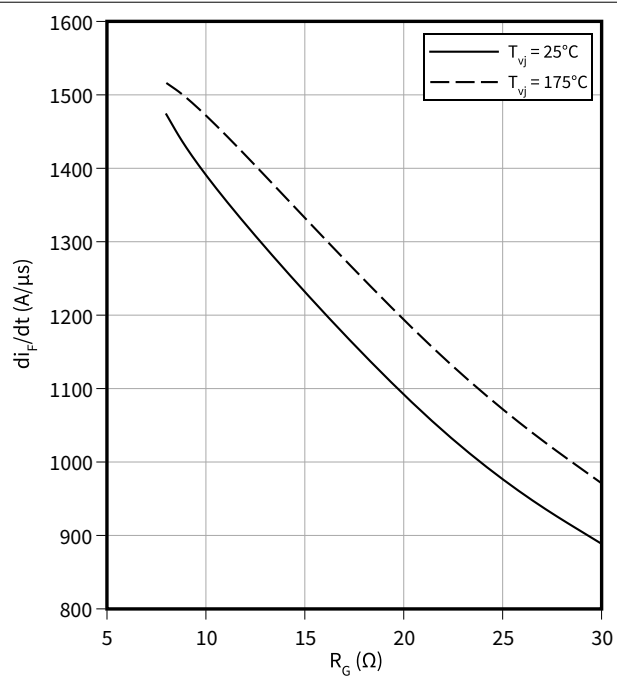
$V_R = 600\text{ V}, I_F = 75\text{ A}$



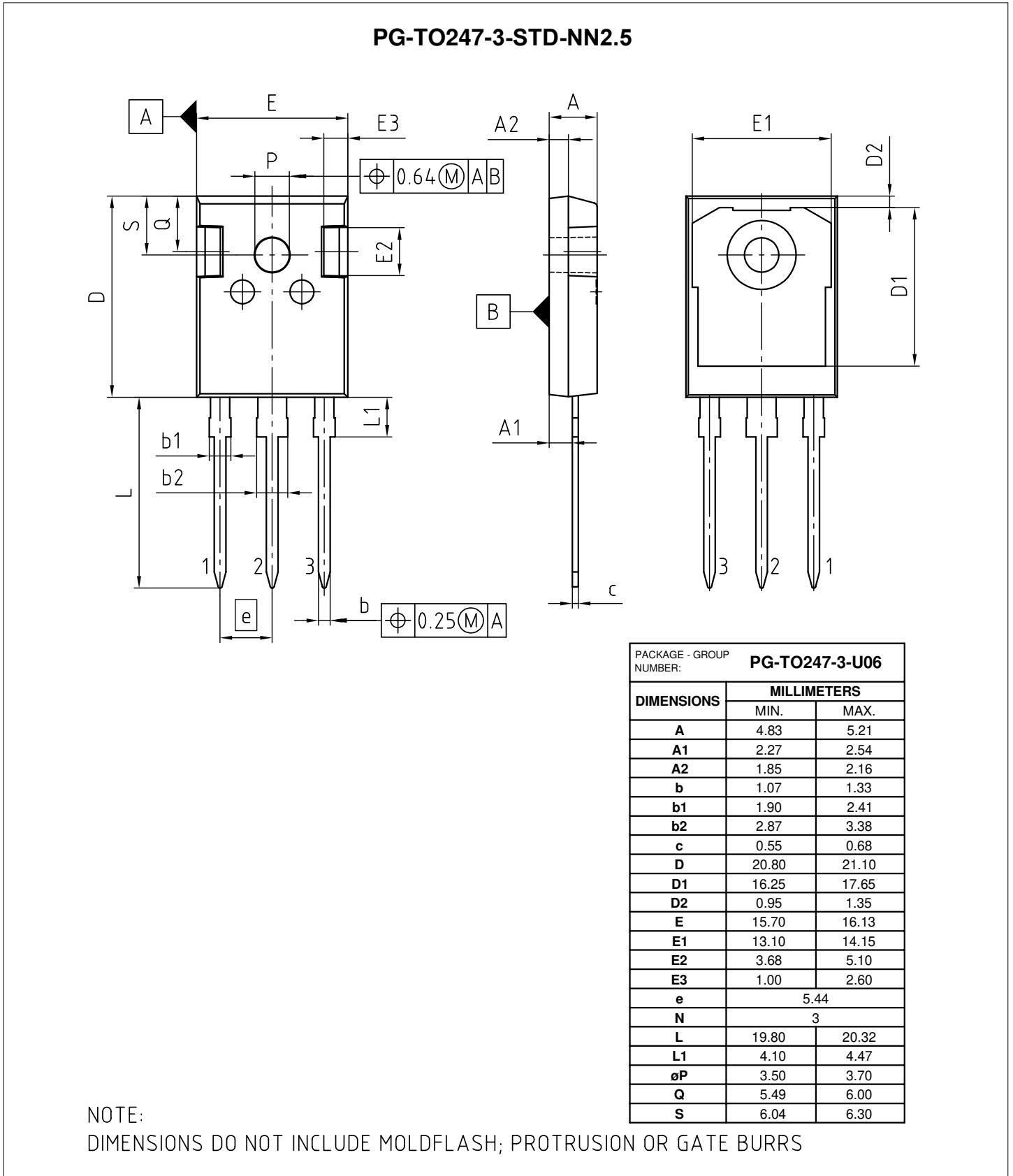
**Typical diode current slope as a function of gate resistor**

$$di_F/dt = f(R_G)$$

$V_R = 600 \text{ V}$ ,  $I_F = 75 \text{ A}$

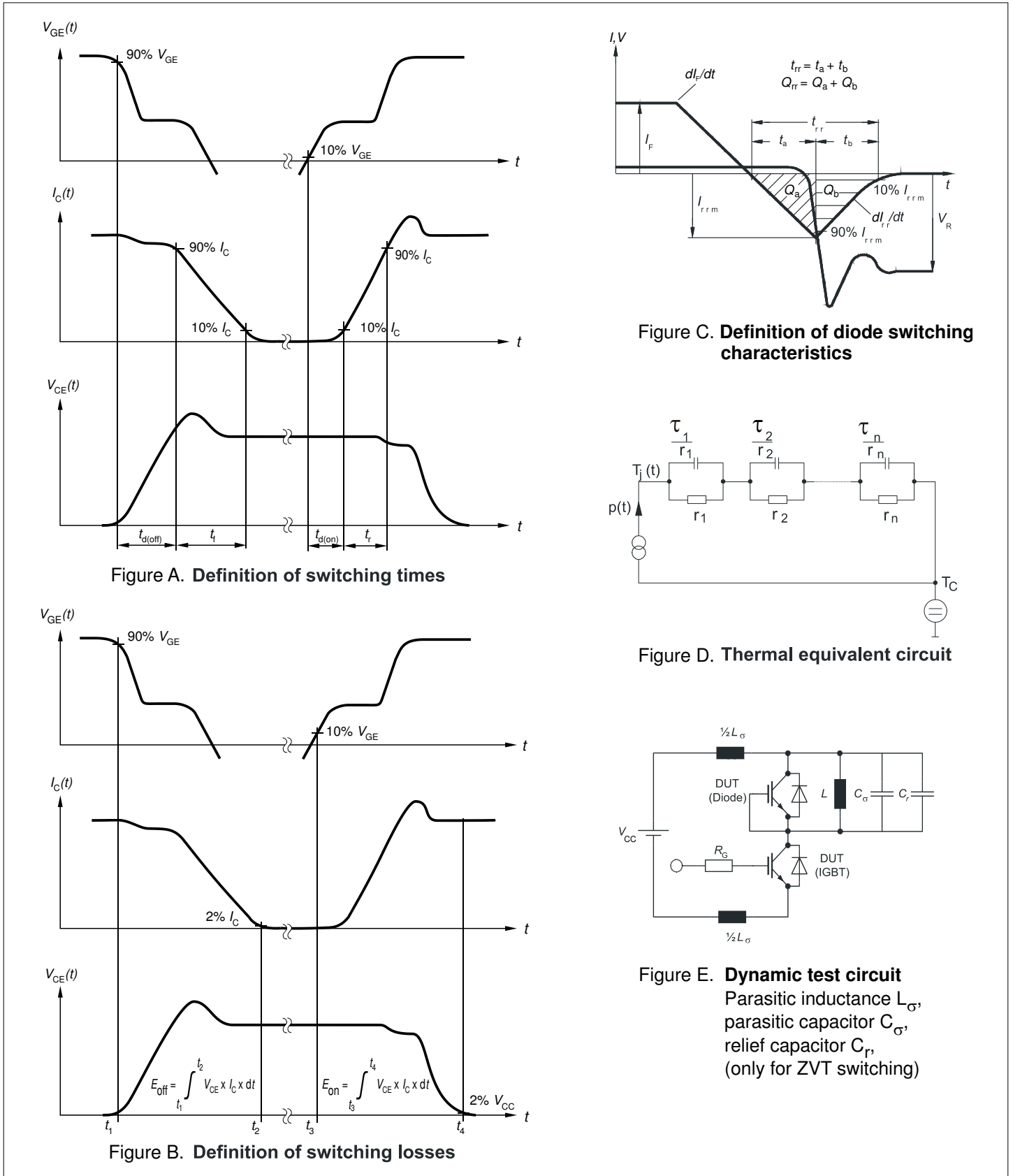


**5 Package outlines**



**Figure 1**

**6 Testing conditions**



**Figure 2**

## Revision history

| Document revision | Date of release | Description of changes                                |
|-------------------|-----------------|---|
| 0.10              | 2022-05-02      | Target datasheet                                      |
| 0.20              | 2022-05-19      | Editorial changes                                     |
| 0.30              | 2022-06-01      | Editorial changes                                     |
| 1.00              | 2022-11-09      | Final datasheet                                       |
| 1.10              | 2022-11-29      | Update of potential applications                      |
| 1.20              | 2023-07-03      | Figures on page 9 and 11 updated<br>Editorial changes |



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